

Reference Specification

Safety Standard Certified Lead Type Disc Ceramic Capacitors for Consumer Electronics & Industrial Equipment /Type KX

Product specifications in this catalog are as of Apr. 2024, and are subject to change or obsolescence without notice.

Please consult the approval sheet before ordering. Please read rating and Cautions first.

↑ CAUTION

1. OPERATING VOLTAGE

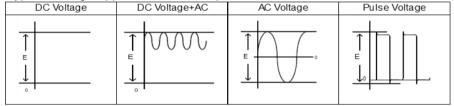
Do not apply a voltage to a safety standard certified product that exceeds the rated voltage as called out in the specifications. Applied voltage between the terminals of a safety standard certified product shall be less than or equal to the rated voltage (+10 %). When a safety standard certified product is used as a DC voltage product, the AC rated voltage value becomes the DC rated voltage value. (Example:AC250 V (r.m.s.) rated product can be used as DC250 V (+10 %) rated product.)

If both AC rated voltage and DC rated voltage are specified, apply the voltage lower than the respective rated voltage.

- 1-1. When a safety standard certified product is used in a circuit connected to a commercial power supply, ensure that the applied commercial power supply voltage including fluctuation should be less than 10 % above its rated voltage.
- 1-2. When using a safety standard certified product as a DC rated product in circuits other than those connected to a commercial power supply.

When AC voltage is superimposed on DC voltage, the zero-to-peak voltage shall not exceed the rated DC voltage. When AC voltage or pulse voltage is applied, the peak-to-peak voltage shall not exceed the rated DC voltage.

Typical Voltage Applied to the DC Capacitor



(E: Maximum possible applied voltage.)

1-3. Influence of over voltage

Over voltage that is applied to the capacitor may result in an electrical short circuit caused by the breakdown of the internal dielectric layers. The time duration until breakdown depends on the applied voltage and the ambient temperature.

2. OPERATING TEMPERATURE AND SELF-GENERATED HEAT

Keep the surface temperature of a capacitor below the upper limit of its rated operating temperature range. Be sure to take into account the heat generated by the capacitor itself.

When the capacitor is used in a high-frequency current, pulse current or the like, it may have the self-generated heat due to dielectric-loss. Applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C.

In case of Class 2 capacitors (Temp.Char. : B,E,F, etc.), applied voltage should be the load such as self-generated heat is within 20 °C on the condition of atmosphere temperature 25 °C.

Since the self-heating is low in the Class 1 capacitors (Temp.Char.: SL etc.), the allowable power becomes extremely high compared to the Class 2 capacitors.

However, when a load with self-heating of 20°C is applied at the rated voltage, the allowable power may be exceeded. Please confirm that there is no rising trend of the capacitor's surface temperature and that the surface temperature of the capacitor does not exceed the maximum operating temperature.

Excessive generation of heat may cause deterioration of the characteristics and reliability of the capacitor.

When measuring the self-heating temperature, be aware that accurate measurement may not be possible due to the following effects.

- · The heat generated by other parts
- Air flow such as convection and cooling fans
- Temperature sensor used for measuring surface temperature of capacitor
 In the case using a thermocouple, it is recommended that use a K thermocouple of Φ0.1mm with less heat capacity.

3. TEST CONDITION FOR WITHSTANDING VOLTAGE

3-1. TEST EQUIPMENT

Test equipment for AC withstanding voltage should be used with the performance of the wave similar to 50/60 Hz sine wave.

If the distorted sine wave or over load exceeding the specified voltage value is applied, the defective may be caused.

3-2. VOLTAGE APPLIED METHOD

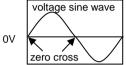
When the withstanding voltage is applied, capacitor's lead or terminal should be firmly connected to the out-put of the withstanding voltage test equipment, and then the voltage should be raised from near zero to the test voltage.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, test voltage should be applied with the *zero cross. At the end of the test time, the test voltage should be reduced to near zero, and then capacitor's lead or terminal should be taken off the out-put of the withstanding voltage test equipment.

If the test voltage without the raise from near zero voltage would be applied directly to capacitor, the surge voltage may arise, and therefore, the defective may be caused.

*ZERO CROSS is the point where voltage sine wave pass 0 V.

- See the right figure -



4. FAIL-SAFE

Capacitors that are cracked by dropping or bending of the board may cause deterioration of the insulation resistance, and result in a short.

If the circuit being used may cause an electrical shock, smoke or fire when a capacitor is shorted, be sure to install fail-safe functions, such as a fuse, to prevent secondary accidents.

5. OPERATING AND STORAGE ENVIRONMENT

The insulating coating of capacitors does not form a perfect seal; therefore, do not use or store capacitors in a corrosive atmosphere, especially where chloride gas, sulfide gas, acid, alkali, salt or the like are present. And avoid exposure to moisture. Before cleaning, bonding, or molding this product, verify that these processes do not affect product quality by testing the performance of a cleaned, bonded or molded product in the intended equipment. Store the capacitors where the temperature and relative humidity do not exceed -10 to 40 °C and 15 to 85 %.

Use capacitors within 6 months after delivered. Check the solderability after 6 months or more.

6. VIBRATION AND IMPACT

Do not expose a capacitor or its leads to excessive shock or vibration during use.

- 6-1. Mechanical shock due to being dropped may cause damage or a crack in the dielectric material of the capacitor.
 - Do not use a dropped capacitor because the quality and reliability may be deteriorated.
- 6-2. Excessive shock or vibration may cause to fatigue destruction of lead wires mounted on the circuit board. If necessary, take measures to hold a capacitor on the circuit boards by adhesive, molding resin or coating and other.

Please confirm there is no influence of holding measures on the product with an intended equipment.

7. SOLDERING

When soldering this product to a PCB/PWB, do not exceed the solder heat resistance specification of the capacitor. Subjecting this product to excessive heating could melt the internal junction solder and may result in thermal shocks that can crack the ceramic element.

Please verify that the soldering process does not affect the quality of capacitors.

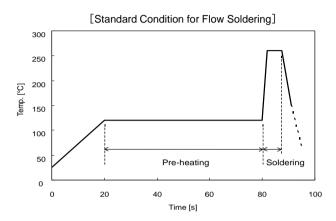
7-1. Flow Soldering

Soldering temperature : 260 °C max.

Soldering time : 7.5 s max.

Preheating temperature : 120 °C max.

Preheating time : 60 s max.



7-2. Reflow Soldering

Do not apply reflow soldering.

7-3. Soldering Iron

Temperature of iron-tip : 400 °C max. Soldering iron wattage : 50 W max. Soldering time : 3.5 s max.

8. BONDING, RESIN MOLDING AND COATING

Before bonding, molding or coating this product, verify that these processes do not affect the quality of capacitor by testing the performance of the bonded, molded or coated product in the intended equipment.

In case of the amount of applications, dryness / hardening conditions of adhesives and molding resins containing organic solvents (ethyl acetate, methyl ethyl ketone, toluene, etc.) are unsuitable, the outer coating resin of a capacitor is damaged by the organic solvents and it may result, worst case, in a short circuit.

The variation in thickness of adhesive, molding resin or coating may cause a outer coating resin cracking and/or ceramic element cracking of a capacitor in a temperature cycling.

9. TREATMENT AFTER BONDING, RESIN MOLDING AND COATING

When the outer coating is hot (over 100 $^{\circ}$ C) after soldering, it becomes soft and fragile. So please be careful not to give it mechanical stress.

Failure to follow the above cautions may result, worst case, in a short circuit and cause fuming or partial dispersion when the product is used.

10. LIMITATION OF APPLICATIONS

The products listed in the specification(hereinafter the product(s) is called as the "Product(s)") are designed and manufactured for applications specified in the specification. (hereinafter called as the "Specific Application")

We shall not warrant anything in connection with the Products including fitness, performance, adequateness, safety, or quality, in the case of applications listed in from (1) to (11) written at the end of this precautions, which may generally require high performance, function, quality, management of production or safety.

Therefore, the Product shall be applied in compliance with the specific application.

WE DISCLAIM ANY LOSS AND DAMAGES ARISING FROM OR IN CONNECTION WITH THE PRODUCTS INCLUDING BUT NOT LIMITED TO THE CASE SUCH LOSS AND DAMAGES CAUSED BY THE UNEXPECTED ACCIDENT, IN EVENT THAT (i) THE PRODUCT IS APPLIED FOR THE PURPOSE WHICH IS NOT SPECIFIED AS THE SPECIFIC APPLICATION FOR THE PRODUCT, AND/OR (ii) THE PRODUCT IS APPLIED FOR ANY FOLLOWING APPLICATION PURPOSES FROM (1) TO (11) (EXCEPT THAT SUCH APPLICATION PURPOSE IS UNAMBIGUOUSLY SPECIFIED AS SPECIFIC APPLICATION FOR THE PRODUCT IN OUR CATALOG SPECIFICATION FORMS, DATASHEETS, OR OTHER DOCUMENTS OFFICIALLY ISSUED BY US*)

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. Power plant control equipment
- 5. Medical equipment
- 6. Transportation equipment
- 7. Traffic control equipment
- 8. Disaster prevention/security equipment
- 9. Industrial data-processing equipment
- 10. Combustion/explosion control equipment
- 11. Equipment with complexity and/or required reliability equivalent to the applications listed in the above.

For exploring information of the Products which will be compatible with the particular purpose other than those specified in the specification, please contact our sales offices, distribution agents, or trading companies with which you make a deal, or via our web contact form.

Contact form: https://www.murata.com/contactform

*We may design and manufacture particular Products for applications listed in (1) to (11). Provided that, in such case we shall unambiguously specify such Specific Application in the specification without any exception.

Therefore, any other documents and/or performances, whether exist or non-exist, shall not be deemed as the evidence to imply that we accept the applications listed in (1) to (11).

NOTICE

1. CLEANING (ULTRASONIC CLEANING)

- 1-1. Please evaluate the capacitor using actual cleaning equipment and conditions to confirm the quality, and select the solvent for cleaning.
- 1-2. Unsuitable cleaning may leave residual flux or other foreign substances, causing deterioration of electrical characteristics and the reliability of the capacitors.
- 1-3. To perform ultrasonic cleaning, observe the following conditions.

Rinse bath capacity: Output of 20 watts per liter or less.

Rinsing time: 5 min maximum.

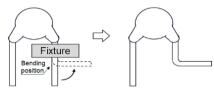
Do not vibrate the PCB/PWB directly.

Excessive ultrasonic cleaning may lead to fatigue destruction of the terminals.

2. SOLDERING AND MOUNTING

- 2-1. Insert the lead wire into the PCB with a distance appropriate to the lead space.
 If the lead wires are inserted into different spacing holes, cracks may occur in the outer resin or the internal element.
- 2-2. When bending the lead wire, excessive force applied to the capacitor body may cause cracks in the outer resin or the internal element. Hold the lead wire closer to the capacitor body than the lead wire bending position with the fixture, then bend it.

(See the right figure)



- 2-3. When cutting and clinching the lead wire, do not apply excessive force to the capacitor body.
- 2-4. When soldering, insert the lead wire into the PCB without mechanically stressing the lead wire.

3. CAPACITANCE CHANGE OF CAPACITORS

· Class 1 capacitors

Capacitance might change a little depending on a surrounding temperature or an applied voltage. Please contact us if you use for the strict time constant circuit.

· Class 2 capacitors

Class 2 capacitors like temperature characteristic B, E and F have an aging characteristic, whereby the capacitor continually decreases its capacitance slightly if the capacitor leaves for a long time. Moreover, capacitance might change greatly depending on a surrounding temperature or an applied voltage. So, it is not likely to be able to use for the time constant circuit. Please contact us if you need a detail information.

4. CHARACTERISTICS EVALUATION IN THE ACTUAL SYSTEM

- 4-1. Evaluate the capacitor in the actual system, to confirm that there is no problem with the performance and specification values in a finished product before using.
- 4-2. Since a voltage dependency and temperature dependency exists in the capacitance of Class 2 ceramic capacitors, the capacitance may change depending on the operating conditions in the actual system. Therefore, be sure to evaluate the various characteristics, such as the leakage current and noise absorptivity, which will affect the capacitance value of the capacitor.
- 4-3. In addition, voltages exceeding the predetermined surge may be applied to the capacitor by the inductance in the actual system.
 - Evaluate the surge resistance in the actual system as required.
- 4-4. When using Class 2 ceramic capacitors in AC or pulse circuits, the capacitor itself vibrates at specific frequencies and noise may be generated. Moreover, when the mechanical vibration or shock is added to capacitor, noise may occur.

⚠ NOTE

- 1. Please make sure that your product has been evaluated in view of your specifications with our product being mounted to your product.
- 2. You are requested not to use our product deviating from this specification.

1.Application

This product specification is applied to Safety Standard Certified Lead Type Disc Ceramic Capacitors Type KX.

The safety standard certification is obtained as Class X1, Y1.

1. Specific applications:

- •Consumer Equipment: Products that can be used in consumer equipment such as home appliances, audio/visual equipment, communication equipment, information equipment, office equipment, and household robotics, and whose functions are not directly related to the protection of human life and property.
- •Industrial Equipment: Products that can be used in industrial equipment such as base stations, manufacturing equipment, industrial robotics equipment, and measurement equipment, and whose functions do not directly relate to the protection of human life and property.
- · Medial Equipment [GHTF A/B/C] except for Implant Equipment: Products suitable for use in medical devices designated under the GHTF international classifications as Class A or Class B (the functions of which are not directly involved in protection of human life or property) or in medical devices other than implants designated under the GHTF international classifications as Class C (the malfunctioning of which is considered to pose a comparatively high risk to the human body).
- ·Automotive infotainment/comfort equipment: Products that can be used for automotive equipment such as car navigation systems and car audio systems that do not directly relate to human life and whose structure, equipment, and performance are not specifically required by law to meet technical standards for safety assurance or environmental protection.
- 2.Unsuitable Application: Applications listed in "Limitation of applications" in this product specification.

Approval standard and certified number

	Standard number	* Certified number	Rated voltage
UL	UL60384-14	E37921	
CSA	CSA E60384-14	1343810	
VDE	EN60384-14, IEC60384-14	40002831	1
BSI	EN62368-1, EN60384-14, IEC60384-14	KM 37901	
SEMKO		SE-S2101013	X1: AC440 V(r.m.s.)
DEMKO	EN60384-14,	D-08838	Y1: AC250 V(r.m.s.)
FIMKO	IEC60384-14	FI/41217	11. AC250 V(1.111.5.)
NEMKO	IEC60364-14	P21225672	
ESTI		24.0026	1
IMQ	EN60384-14	V4069	1
CQC	GB/T6346.14	CQC04001011643	
ктс	KC60384-14	HU03008-4003, HU03008-4004	

^{*}Above Certified number may be changed on account of the revision of standards and the renewal of certification.

2.Rating

2-1. Operating temperature range

-40 ~ 125°C

2-2.Rated Voltage

X1: AC440 V(r.m.s.) Y1: AC250 V(r.m.s.)

2-3.Part number configuration

ex.)

DE1	1X	KX	680	J	J4	В	C05F
Series	Temperature	Certified	Capacitance	Capacitance	Lead	Package	Individual
	Characteristics	Type		Tolerance	Style		Specification

Series

DE1 denotes class X1,Y1.

• Temperature Characteristics

Please confirm detailed specification on [Specification and test methods].

Code	Temperature Characteristics
1X	SL

Certified Type

This denotes safety certified type name Type KX.

Capacitance

The first two digits denote significant figures; the last digit denotes the multiplier of 10 in pF. ex.) In case of 680.

$$68 \times 10^0 = 68 \text{ pF}$$

• Capacitance Tolerance

Please refer to [Part number list].

• Lead Style

* Please refer to [Part number list].

Code	Lead Style
A*	Vertical crimp long type
B*	Vertical crimp short type
J*	Vertical crimp short type
N*	Vertical crimp taping type

Package

Code	Package
Α	Ammo pack taping type
В	Bulk type

• Individual Specification

In case part number cannot be identified without 'individual specification', it is added at

the end of part number.

Code	Individual Specification
C05F	 →Halogen Free Br≤900ppm, Cl≤900ppm Br+Cl≤1500ppm →CP wire

Note) Murata part numbers might be changed depending on lead code or any other changes. Therefore, please specify only the type name(KX) and capacitance of products in the parts list when it is required for applying safety standard of electric equipment.

3.Marking

<Right side> <Reverse side>

Certified type ΚX Rated voltage mark X1 440~ Y1 250~

Capacitance Actual value Code

Capacitance tolerance CQC Approval mark: (CQC) Company name code (Made in Tailand) KTC Approval mark

Manufacturing year : Letter code

(The last digit of A.D. year.)

Manufacturing month : Code

> Feb./Mar. → 2 Aug./Sep. → 8 Apr./May → 4 Oct./Nov. → O Jun./Jul. → 6 Dec./Jan. → D

UL Approval mark

CSA Approval mark

VDE Approval mark

BSI Approval mark **BSI**

SEMKO Approval mark

DEMKO Approval mark

FIMKO Approval mark

NEMKO Approval mark

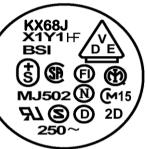
ESTI Approval mark

IMQ Approval mark

Class code **X1Y1**

HF Halogen free mark

Rated voltage mark : 250~ (Example) <Right side>

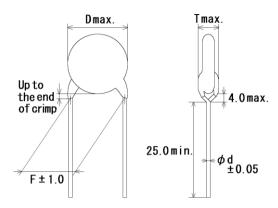




<Reverse side>

4. Part number list

Vertical crimp long type (Lead Style: A*)

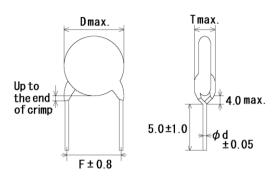


Note) The mark '*' of Lead Style differ from lead spacing (F) and lead diameter (d). Please see the following list about details.

Unit: mm

Customer	Murata	T.C. Cap.	Cap. (pF)	Сар.	Сар.	Di	mensi	m)	Lead	Pack
Part Number	Part Number	1.0.		tol.	D	Т	F	d	Style	qty. (pcs)
	DE11XKX100JA4BC05F	SL	10	±5%	9.0	8.0	10.0	0.6	A4	250
	DE11XKX150JA4BC05F	SL	15	±5%	9.0	8.0	10.0	0.6	A4	250
	DE11XKX220JA4BC05F	SL	22	±5%	9.0	8.0	10.0	0.6	A4	250
	DE11XKX330JA4BC05F	SL	33	±5%	9.0	8.0	10.0	0.6	A4	250
	DE11XKX470JA4BC05F	SL	47	±5%	9.0	8.0	10.0	0.6	A4	250
	DE11XKX680JA4BC05F	SL	68	±5%	9.0	8.0	10.0	0.6	A4	250

·Vertical crimp short type
(Lead Style: B*)



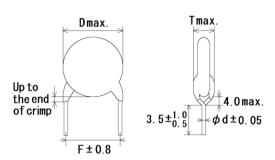
Note) The mark '*' of Lead Style differ from lead spacing (F) and lead diameter (d). Please see the following list about details.

Unit: mm

									OTHE.	
Customer	Murata	T.C.	Cap. Cap. Dimension (mm)				m)	Lead	Pack	
Part Number	Part Number	1.0.	(pF)	tol.	D	Τ	F	d	Style	qty. (pcs)
	DE11XKX100JB4BC05F	SL	10	±5%	9.0	8.0	10.0	0.6	B4	500
	DE11XKX150JB4BC05F	SL	15	±5%	9.0	8.0	10.0	0.6	B4	500
	DE11XKX220JB4BC05F	SL	22	±5%	9.0	8.0	10.0	0.6	B4	500
	DE11XKX330JB4BC05F	SL	33	±5%	9.0	8.0	10.0	0.6	B4	500
	DE11XKX470JB4BC05F	SL	47	±5%	9.0	8.0	10.0	0.6	B4	500
	DE11XKX680JB4BC05F	SL	68	±5%	9.0	8.0	10.0	0.6	B4	500

PNLIST

-Vertical crimp short type
(Lead Style: J*)



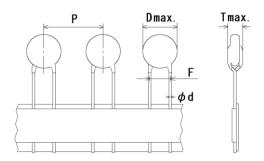
Note) The mark '*' of Lead Style differ from lead spacing (F) and lead diameter (d). Please see the following list about details.

Unit: mm

Customer		· · · -		Dii	mensi	m)	Lead	Pack		
Part Number	Part Number	1.0.	(pF)	tol.	D	Т	F	d	Style	qty. (pcs)
	DE11XKX100JJ4BC05F	SL	10	±5%	9.0	8.0	10.0	0.6	J4	500
	DE11XKX150JJ4BC05F	SL	15	±5%	9.0	8.0	10.0	0.6	J4	500
	DE11XKX220JJ4BC05F	SL	22	±5%	9.0	8.0	10.0	0.6	J4	500
	DE11XKX330JJ4BC05F	SL	33	±5%	9.0	8.0	10.0	0.6	J4	500
	DE11XKX470JJ4BC05F	SL	47	±5%	9.0	8.0	10.0	0.6	J4	500
	DE11XKX680JJ4BC05F	SL	68	±5%	9.0	8.0	10.0	0.6	J4	500

PNLIST

·Vartical crimp taping type (Lead Style:N*)



Note) The mark '*' of Lead Style differ from lead spacing (F), lead diameter (d) and pitch of compoment (P). Please see the following list or taping specification about details.

Unit: mm

Customer	Customer Murata T.C.		Cap.	Cap.	Dimension (mm)					Lead	Pack qty.
Part Number	Part Number	1.0.	(pF)	tol.	D T		F	d	Р	Sivie	
	DE11XKX100JN4AC05F	SL	10	±5%	9.0	8.0	10.0	0.6	25.4	N4	500
	DE11XKX150JN4AC05F	SL	15	±5%	9.0	8.0	10.0	0.6	25.4	N4	500
	DE11XKX220JN4AC05F	SL	22	±5%	9.0	8.0	10.0	0.6	25.4	N4	500
	DE11XKX330JN4AC05F	SL	33	±5%	9.0	8.0	10.0	0.6	25.4	N4	500
	DE11XKX470JN4AC05F	SL	47	±5%	9.0	8.0	10.0	0.6	25.4	N4	500
	DE11XKX680JN4AC05F	SL	68	±5%	9.0	8.0	10.0	0.6	25.4	N4	500

5. Sn	ecification		IVererenc	1
No.	T	Item	Specification	Test Method (Ref. Standard:JIS C 5101(all parts), IEC60384(all parts))
1	Appearance and		No marked defect on appearance form	
			and dimensions.	of defect.
			Please refer to [Part number list].	Dimensions should be measured with slide calipers.
	Marking	In	To be easily legible.	The capacitor should be inspected by naked eyes.
3	Dielectric strength	Between lead wires	No failure.	The capacitor should not be damaged when AC4,000 V(r.m.s.) <50/60 Hz> is applied between the lead wires for 60 s.
		Terminal To External Resin	No failure.	First, the terminals of the capacitor should be connected together. Then, a metal foil should be closely wrapped around the body of the capacitor to the distance of about 3 to 6 mm from each terminal. Then, the capacitor should be inserted into a container filled with metal balls of about 1 mm diameter. Finally, AC4,000 V(r.m.s.) <50/60 Hz> is applied for 60 s between the capacitor lead wires and metal balls.
4	Insulation Resis	tance (I.R.)	10,000 MΩ min.	The insulation resistance should be measured with DC500±50 V within 60±5 s of charging. The voltage should be applied to the capacitor through a resistor of 1
				ΜΩ.
5	Capacitance		Within specified tolerance.	The capacitance should be measured at 20 °C with 1±0.1 kHz (Char. SL: 1±0.1 MHz) and AC1±0.2 V(r.m.s.) max
6	Q		Char. SL:	The dissipation factor and Q should be measured at 20 °C with 1±0.1
			Q \geq 400+20C ^{*2} (30 pF under) Q \geq 1,000 (30 pF min.)	kHz (Char. SL : 1±0.1 MHz) and AC1±0.2 V(r.m.s.) max
	Dissipation Fact	or (D.F.)	Q \ge 1,000 (30 pF min.) Char. B,E: DF \le 0.025	-
7	Temperature ch		Char. SL: +350 to -1,000 ppm/ °C	The capacitance measurement should be made at each step specified
			(Temp. range : 20 to 85 °C) Char. B : Within ±10 % Char. E : Within +20/-55 % (Temp. range : -25 to 85 °C) Ste Temp	•
8	Active flammabi		The cheese-cloth should not be on fire	The capacitors should be individually wrapped in at least one but more than two complete layers of cheese-cloth. The capacitor should be subjected to 20 discharges. The interval between successive discharges should be 5 s. The UAc should be maintained for 2 min after the last discharge. C1,2 : 1 µF±10 %, C3 : 0.033 µF±5 % 10 kV L1 to L4 : 1.5 mH±20 % 16 A Rod core choke R : 100 Ω±2 %, Ct : 3 µF±5 % 10 kV UAc : UR±5 % UR : Rated voltage Cx : Capacitor under test F : Fuse, Rated 10 A Ut : Voltage applied to Ct
*2 "C"	expresses nom	inal capacitance	value(pF)	

ESKX03H

No.	Tes	t Item	Specification	Test Method (Ref. Standard:JIS C 5101(all parts), IEC60384(all parts))
9	Robustness of terminations	Tensile	Lead wire should not cut off. Capacitor should not be broken.	Fix the body of capacitor, a tensile weight gradually to each lead wire in the radial direction of capacitor up to 10 N and keep it for 10±1 s.
		Bending		With the termination in its normal position, the capacitor is held by its body in such a manner that the axis of the termination is vertical; a mass applying a force of 5 N is then suspended from the end of the termination. The body of the capacitor is then inclined, within a period of 2 to 3 s, through an angle of approximately 90 ° in the vertical plane and then returned to its initial position over the same period of time; this operation constitutes one bend. One bend immediately followed by a second bend in the opposite direction.
10	Vibration	Appearance	No marked defect.	The capacitor should be firmly soldered to the supporting lead wire and
	resistance	Capacitance	Within the specified tolerance.	vibration which is 10 to 55 Hz in the vibration frequency range, 1.5 mm
		Q	Char. SL : Q≧400+20C ^{*2} (30 pF under) Q≧ 1,000 (30 pF min.)	in total amplitude, and about 1 min in the rate of vibration change from 10 Hz to 55 Hz and back to 10 Hz is applied for a total of 6 h; 2 h each in 3 mutually perpendicular directions.
		Dissipation Factor (D.F.)	Char. B,E : DF≦0.025	
11	Solderability of	leads	Lead wire should be soldered with uniformly coated on the axial direction over 3/4 of the circumferential direction.	The lead wire of a capacitor should be dipped into a rosin ethanol (25% rosin in weight propotion). Immerse in solder solution for 2±0.5 s. In both cases the depth of dipping is up to about 1.5 to 2.0 mm from the root of lead wires. Temp. of solder: 245±5 °C
12	Soldering	Appearance	No marked defect.	Solder temperature : 350±10 °C or 260±5 °C
	effect (Non-preheat)	Capacitance change	Within ±10 %	Immersion time : 3.5±0.5 s (In case of 260±5 °C : 10±1 s) The depth of immersion is up to about 1.5 to 2.0 mm from the root of lead wires.
		I.R.	1,000 MΩ min.	
		Dielectric strength	Per item 3	Thermal insulating 1.5 to 2.0mm
				Pre-treatment : Capacitor should be stored at 85±2 °C for 1 h, then placed at *1 room condition for 24±2 h before initial measurements.
				Post-treatment : Capacitor should be stored for 1 to 2 h at [™] room condition.
13	Soldering	Appearance	No marked defect.	First the capacitor should be stored at 120+0/-5 °C for 60+0/-5 s. Then
	effect (On-preheat)	Capacitance change	Within ±10 %	as in figure, the lead wires should be immersed solder of 260+0/-5 °C up to 1.5 to 2.0 mm from the root of terminal for 7.5+0/-1 s.
		I.R.	1,000 MΩ min.	
		Dielectric strength	Per item 3	Thermal insulating 1.5 to 2.0mm Moiten solder
				Pre-treatment : Capacitor should be stored at 85±2 °C for 1 h, then placed at ¹ room condition for 24±2 h before

^{*1 &}quot;room condition" Temperature : 15 to 35 °C, Relative humidity : 45 to 75 %, Atmospheric pressure : 86 to 106 kPa *2 "C" expresses nominal capacitance value(pF)

ESKX03H

			Referenc	o only				
N	T =		T Occurrence	T+ M-+				
No.			Specification	Test Method (Ref. Standard:JIS C 5101(all parts), IEC60384(all parts))				
14	Flame test		The capacitor flame discontinue as follows.	The capacitor should be subjected to applied flame for 15 s. and then removed for 15 s until 5 cycles.				
			Cycle Time	Capacitor				
			1 to 4 30 s max.	16 Flame				
			5 60 s max.	/				
				* * * * * * * * * * * * * * * * * * *				
				Gas Burner (in mm)				
15	Passive flammability		The burning time should not be	The capacitor under test should be held in the flame in the position				
			exceeded the time 30 s.	which best promotes burning.				
			The tissue paper should not ignite.	Time of exposure to flame is for 30 s.				
				Length of flame : 12±1 mm				
				Gas burner : Length 35 mm min.				
				Inside Dia. 0.5±0.1 mm				
				Outside Dia. 0.9 mm max.				
				Gas : Butane gas Purity 95 % min.				
				√ (Capacitor				
				About 8mm				
				Gas burner Flame				
				45 200±5mm				
				—————————————————————————————————————				
				About 10mm thick board				
16	Humidity	Appearance	No marked defect.	Set the capacitor for 500±12 h at 40±2 °C in 90 to 95 % relative				
	(Under steady state)	Capacitance	Char. SL : Within ±5 %	humidity.				
		change	Char. B : Within ±10 %	Post-treatment : Capacitor should be stored for 1 to 2 h at *1room condition.				
			Char. E: Within ±15 %					
		Q	Char. SL:	Condition.				
			Q≧ 275+5/2C*2 min.(30 pF under)					
		Dissipation	Q≧350 (30 pF min.)	4				
		Factor (D.F.)	Char. B, E : DF ≦ 0.05					
	I.R.		3,000 MΩ min.					
		Dielectric	Per item 3					
17	Llumidit:	strength	No marked defeat	Apply the reted voltage for EOO 12 h at 40 2 °C in 00 to 05 07 relative				
17	Humidity loading	Appearance	No marked defect. Char. SL : Within ±5 %	Apply the rated voltage for 500±12 h at 40±2 °C in 90 to 95 % relative humidity.				
		Capacitance change	Char. SL: Within ±5 % Char. B: Within ±10 %	The state of the s				
		change	Char. E: Within ±15 %	Post-treatment : Capacitor should be stored for 1 to 2 h at *1room				
		Q	Char. SL:	condition.				
			$Q \ge 275 + 5/2C^{2} \text{ min.} (30 \text{ pF under})$					
			Q≧350 (30 pF min.)					
		Dissipation Factor (D.F.)	Char. B, E : DF ≦ 0.05					
		I.R.	3,000 MΩ min.	7				
		Dielectric	Per item 3	1				
		strength						
*1 "roo			to 25 °C Polativo humidity : 45 to 75 %					

[&]quot;1 "room condition" Temperature : 15 to 35 °C, Relative humidity : 45 to 75 %, Atmospheric pressure : 86 to 106 kPa 12 "C" expresses nominal capacitance value(pF)

1 es	st Item	Specification	res	st Meth	iod (Ref. Standard:	JIS C 5101(all parts), IEC60384(all parts		
Life	Appearance Capacitance change	No marked defect. Within ±20 %	Eac	Impulse voltage Each individual capacitor should be subjected to a 8 kV impulses for three times or more. Then the capacitors are applied to life test. 100 (%) Front time (T1) = 1.7 μ s=1.67T					
	I.R.	3,000 MΩ min.							
	Dielectric strength	Per item 3	1,00 The 125 Thr <50 eac	The capacitors are placed in a circulating air oven	g air oven for a period of inperature of % max ubjected to a AC425 V(r.m.s. frequency, except that once 1,000 V(r.m.s.) for 0.1 s.				
Temperature Cycle	Appearance	No marked defect.							
	change C	Char. SL: Within ±5 % Char. B: Within ±10 % Char. F: Within ±20 %		Step	Temperature(°C)	Time(min)			
				1	-40+0/-3	30			
	Q	Char. SL : Q≧ 275+5/2C ^{*2} min.(30 pF under) Q≧350 (30 pF min.)	1	2	Room temp.	3			
				3	125+3/-0	30			
				4	Room temp.	-			
	Dissipation Factor (D.F.)	Char. B, E : DF ≦ 0.05		Cycle time: 5 cycles Pre-treatment: Capacitor should be stored at 85±2 °C for 1 h, then placed at *1room condition for 24±2 h. Post-treatment: Capacitor should be stored for 4 to 24 h at *1room condition.					
	I.R.	3,000 MΩ min.	Pre						
	Dielectric strength	Per item 3	Pos						
-	Life	Life Appearance Capacitance change I.R. Dielectric strength Temperature Cycle Capacitance change Q Dissipation Factor (D.F.) I.R. Dielectric	Life	Life Appearance No marked defect. Capacitance change I.R. 3,000 MΩ min. Dielectric strength The 1,00 The 125 Thr <50 each change Capacitance change Appearance No marked defect. Capacitance change Strength The 1,00 The 125 Thr <50 each change Char. SL : Within ±5 % Char. B : Within ±10 % Char. E : Within ±20 % Q Char. SL : Q ≥ 275+5/2C *2 min.(30 pF under) Q ≥ 350 (30 pF min.) Dissipation Factor (D.F.) I.R. 3,000 MΩ min. Pre	Life Appearance No marked defect. Impulse v Each individual three time line (change) I.R. 3,000 M Ω min. Dielectric strength The caparation (appearance) The aparation (change) The aparation (change) The aparation (change) Appearance No marked defect. Capacitance (change) Char. SL : Within ± 5 % (char. B : Within ± 10 % (char. B : Within ± 20 % (char. B : Within ± 20 % (char. SL : Within ± 20 % (cha		Life Appearance Capacitance change No marked defect. Impulse voltage Each individual capacitor should be subjethree times or more. Then the capacitors strength I.R. 3,000 MΩ min. The capacitors are placed in a circulating 1,000 h. The air in the oven is maintained at a tent 125±2/-0 °C, and relative humidity of 50 °C, a		

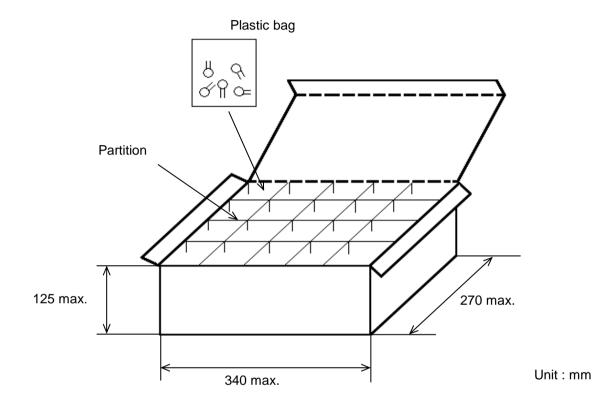
^{1 &}quot;room condition" Temperature: 15 to 35 °C, Relative humidity: 45 to 75 %, Atmospheric pressure: 86 to 106 kPa

^{*2 &}quot;C" expresses nominal capacitance value(pF)

6. Packing specification

•Bulk type (Package : B)

The size of packing case and packing way



The number of packing = *1 Packing quantity × *2 n

*1 : Please refer to [Part number list].

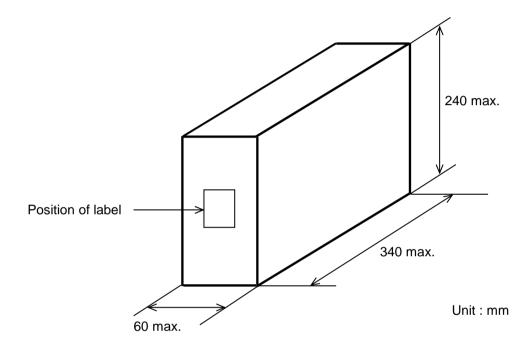
*2 : Standard n = 20 (bag)

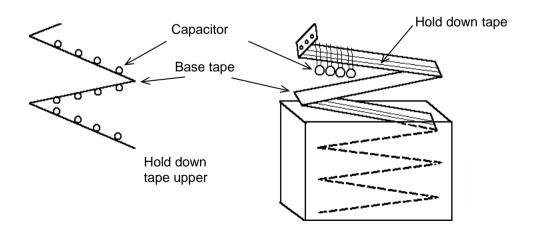
Note)

The outer package and the number of outer packing be changed by the order getting amount.

- ·Ammo pack taping type (Package : A)
 - •The tape with capacitors is packed zigzag into a case.
 - •When body of the capacitor is piled on other body under it.
 - •There should be 3 pitches and over without capacitors in leader and trailer.

The size of packing case and packing way



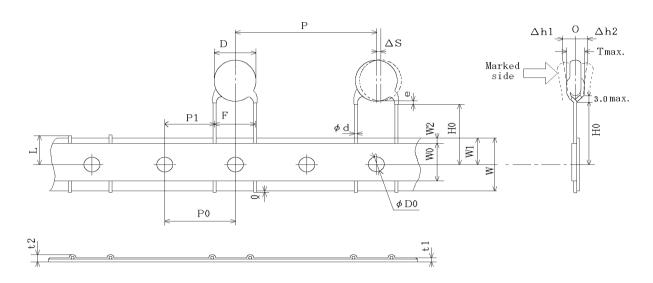


7. Taping specification

7-1. Dimension of capacitors on tape

Vertical crimp taping type < Lead Style : N4 >

Pitch of component 25.4 mm / Lead spacing 10.0 mm

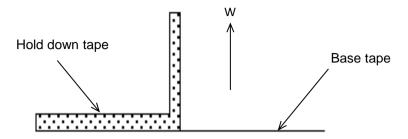


Unit: mm

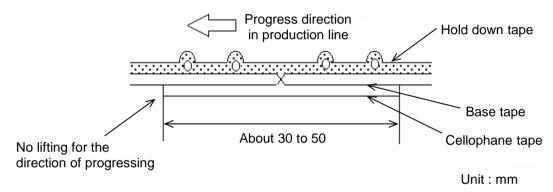
Item		Dimensions	Remarks		
Pitch of component	Р	25.4+/-2.0			
Pitch of sprocket hole	P0	12.7+/-0.3			
Lead spacing	F	10.0+/-1.0			
Length from hole center to lead	P1	7.7+/-1.5			
Body diameter		Please refer to	[Part number list].		
Deviation along tape, left or right		0+/-2.0	They include deviation by lead bend.		
Carrier tape width		18.0+/-0.5			
Position of sprocket hole	W1	9.0+/-0.5	Deviation of tape width direction		
Lead distance between reference and bottom planes		18.0+2.0/-0			
Protrusion length		+0.5~-1.0			
Diameter of sprocket hole		4.0+/-0.1			
Lead diameter		0.60+/-0.05			
Total tape thickness		0.6+/-0.3	They include hold down tape		
Total thickness of tape and lead wire	t2	1.5 max.	thickness.		
Deviation across tape, front		2.0 max.			
Deviation across tape, rear	Δh2	2.0 IIIax.			
Portion to cut in case of defect		11.0+0/-1.0			
Hold down tape width		11.5 min.			
Hold down tape position		1.5+/-1.5			
Coating extension on lead		Up to the end o	f crimp		
Body thickness	Т	Please refer to [Part number list].			

7-2. Splicing way of tape

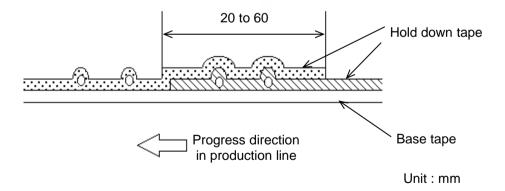
1) Adhesive force of tape is over 3 N at test condition as below.



- 2) Splicing of tape
 - a) When base tape is spliced
 - •Base tape should be spliced by cellophane tape. (Total tape thickness should be less than 1.05 mm.)



- b) When hold down tape is spliced
 - •Hold down tape should be spliced with overlapping. (Total tape thickness should be less than 1.05 mm.)



- c) When both tape are spliced
 - •Base tape and hold down tape should be spliced with splicing tape.
- 3) Missing components
 - •There should be no consecutive missing of more than three components.
 - \bullet The number of missing components should be not more than 0.5 % of total components that should be present in a Ammo pack.